

描述 / Descriptions

TO-220FL 塑封封装 N 沟道 MOS 场效应管。N-CHANNEL MOSFET in a TO-220FL Plastic Package.

特征 / Features

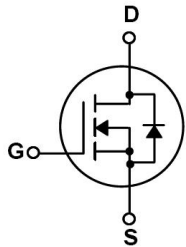
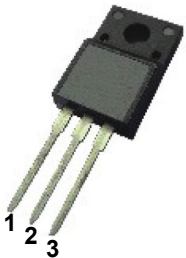
600V 超结功率场效应管, $R_{DS(on)} \times Q_g$ 很低, 100%雪崩测试, 符合 RoHS 要求。

600V Super-Junction Power MOSFET. Very Low $R_{DS(on)} \times Q_g$, 100%avalanche tested, RoHS compliant.

用途 / Applications

用于开关电源、不间断电源、功率因数校正。

Switch Mode Power Supply, Uninterruptible Power Supply, Power Factor Corrections.

内部等效电路 / Equivalent Circuit**引脚排列 / Pinning**

PIN1 : G

PIN 2 : D

PIN 3 : S

放大及印章代码 / h_{FE} Classifications & Marking

见印章说明。See Marking Instructions.

极限参数 / Absolute Maximum Ratings(Ta=25°C)

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Drain-Source Voltage	V_{DS}	600	V
Drain Current	I_D	5	A
Drain Current - Pulsed ^(note1)	$I_{DM}^{(note1)}$	20	A
Gate-Source Voltage	V_{GS}	±30	V
Single Pulsed Avalanche Energy ^(note2)	$E_{AS}^{(note2)}$	67.5	mJ
Repetitive Avalanche Energy ^(note1)	$E_{AR}^{(note1)}$	34	mJ
Avalanche Current ^(note1)	$I_{AR}^{(note1)}$	1	A
Power Dissipation	P_D	35	W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	3.6	°C/W
Junction and Storage Temperature Range	$T_j \quad T_{stg}$	-55~150	°C

电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS}=0V \quad I_D=250\mu A$	600			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=600V \quad V_{GS}=0V$ $T_J=25^\circ C$			1.0	μA
		$V_{DS}=480V \quad V_{GS}=0V$ $T_J=150^\circ C$			10	
Gate-Body Leakage Current Forward	I_{GSS}	$V_{GS}=\pm 30V \quad V_{DS}=0V$			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS} \quad I_D=250\mu A$	2.5		4.5	V
Forward Transconductance ^(note3)	g_{fs}	$V_{DS}=40V \quad I_D=2.5A$		8		S
Static Drain-Source On-Resistance ^(note3)	$R_{DS(on)}$	$V_{GS}=10V \quad I_D=2.5A$		0.77	0.85	Ω
Drain-Source Diode Forward Voltage	V_{SD}	$T_J=25^\circ C \quad I_{SD}=3A$ $V_{GS}=0V$			1.5	V
Input Capacitance	C_{iss}	$V_{DS}=25V \quad V_{GS}=0V$ $f=1.0MHz$		320		pF
Output Capacitance	C_{oss}			75		
Reverse Transfer Capacitance	C_{rss}			4		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=300V \quad I_D=3A$ $R_G=25\Omega$		18		ns
Turn-On Rise Time	t_r			40		
Turn-Off Delay Time	$t_{d(off)}$			50		
Turn-Off Fall Time	t_f			30		

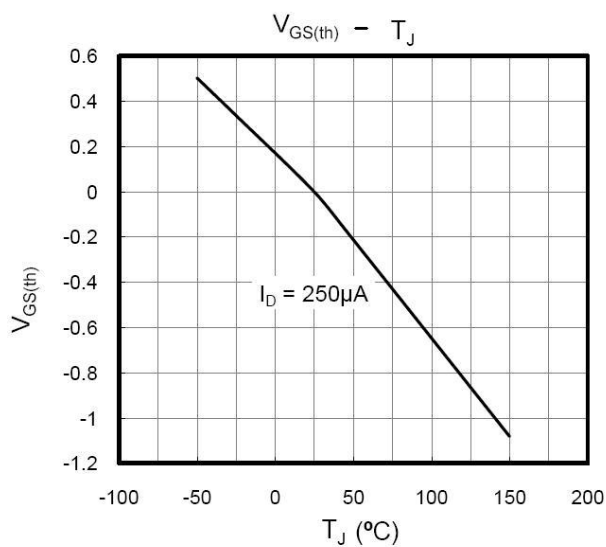
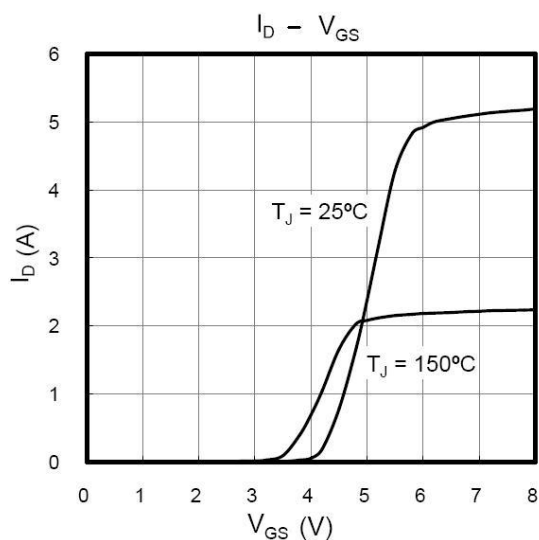
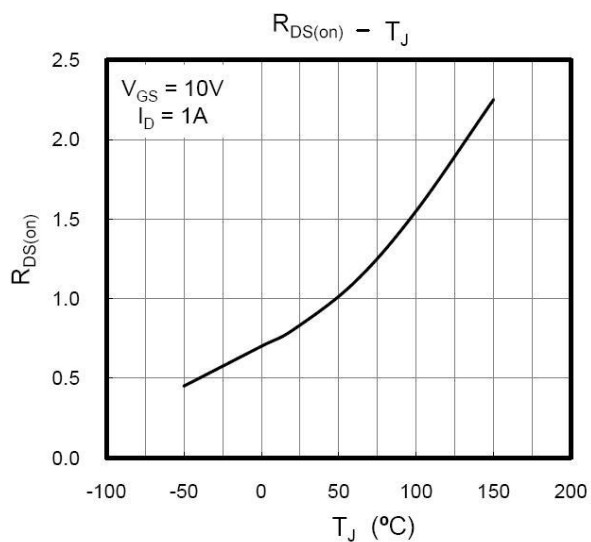
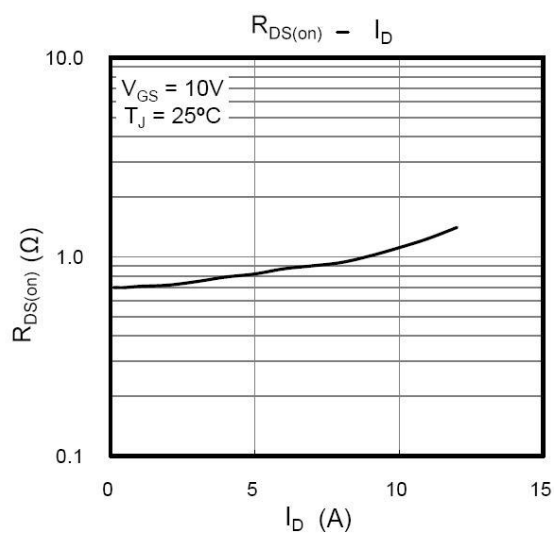
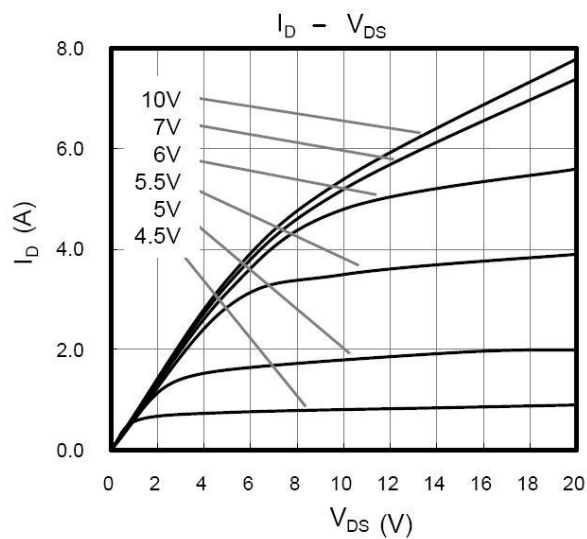
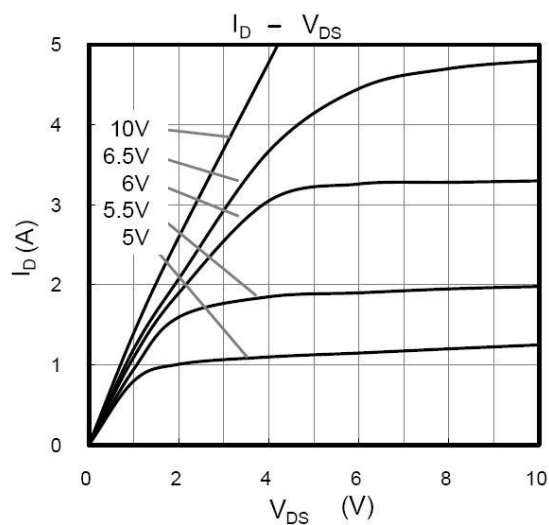
电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Total Gate Charge	Q_g	$V_{DD}=480V$ $I_D=3A$ $V_{GS}=10V$		15		nC
Gate-Source Charge	Q_{gs}			3		
Gate-Drain Charge	Q_{gd}			6		
Continuous Source Current	I_S	$T_C=25^\circ C$			5	A
Pulsed Source Current	I_{SM}				20	
Reverse Recovery Time	t_{rr}	$V_R=480V$ $I_F=I_S$ $di_F/dt=100A/\mu S$		180		ns
Reverse Recovery Charge	Q_{rr}			2.5		μC
Peak Reverse Recovery Current	I_{rrm}			10		A
Total Gate Charge	Q_g			15		nC

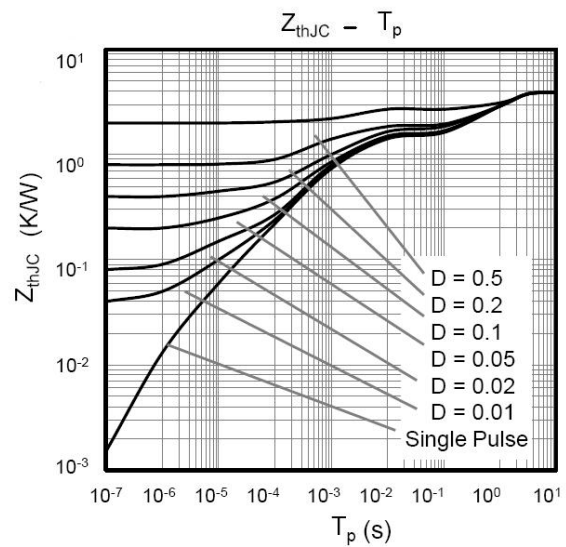
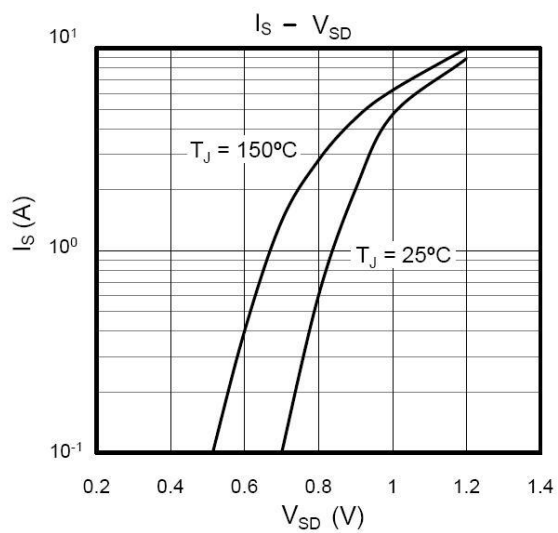
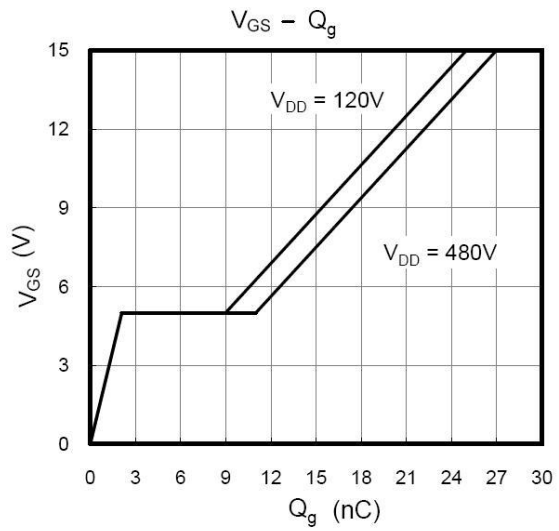
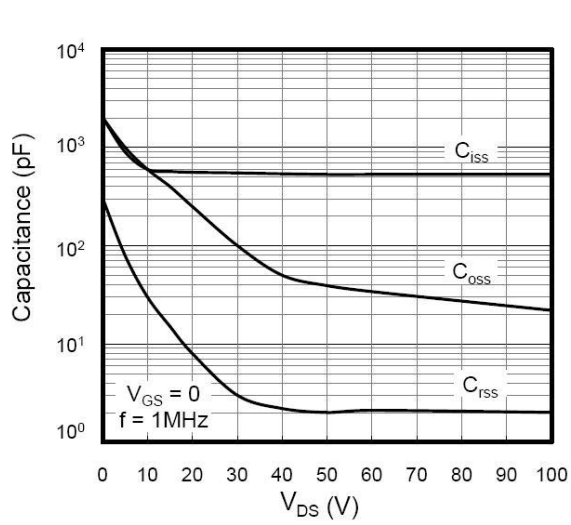
注释/Notes

- 脉冲宽度由最高结温限制
Repetitive Rating: Pulse width limited by maximum junction temperature
- $L=60mH$, $I_{AS}=1.5A$, $V_{DD}=150V$, 起始温度 $T_J=25^\circ C$
 $L=60mH$, $I_{AS}=1.5A$, $V_{DD}=150V$, Starting $T_J=25^\circ C$
- 脉冲测试: 脉冲宽度 $\leq 300\mu s$, 占空比 $\leq 1\%$
Pulse Test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 1\%$

电参数曲线图 / Electrical Characteristic Curve



电参数曲线图 / Electrical Characteristic Curve



测试电路和波形 / Test Circuit and Waveform

Figure A: Gate Charge Test Circuit and Waveform

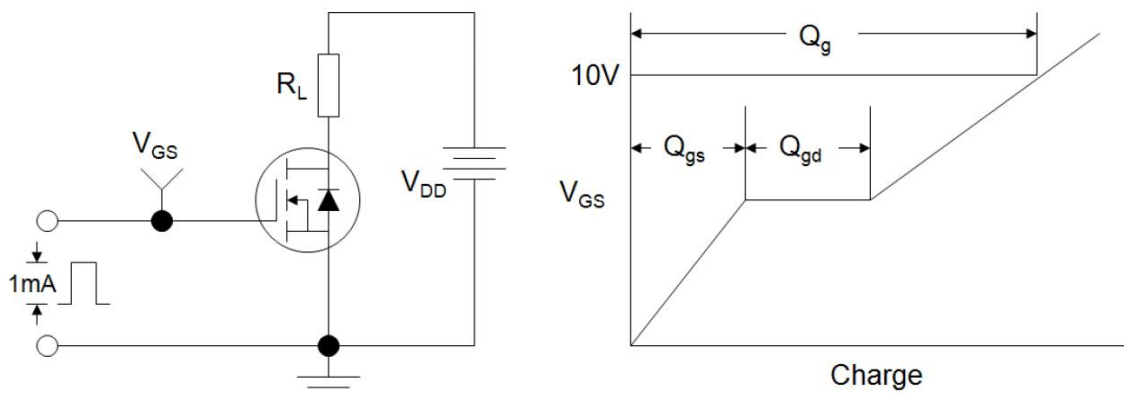


Figure B: Resistive Switching Test Circuit and Waveform

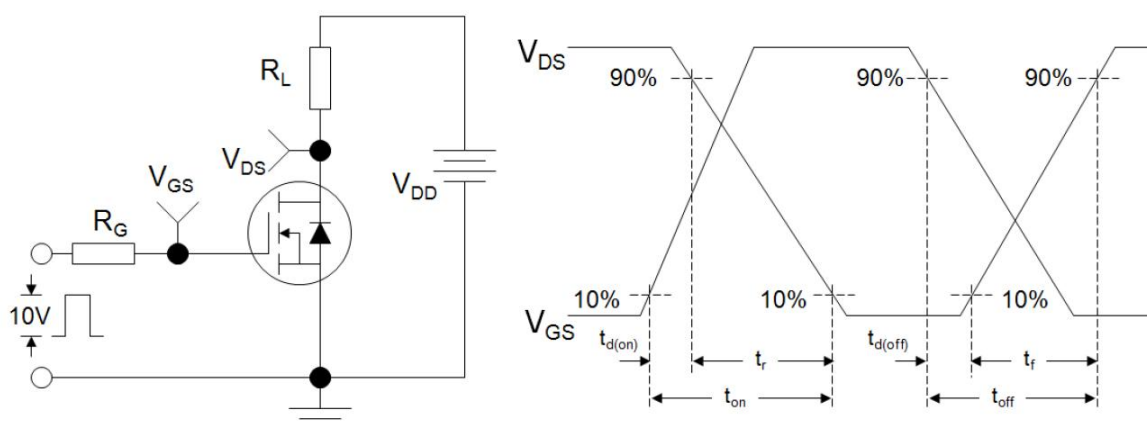
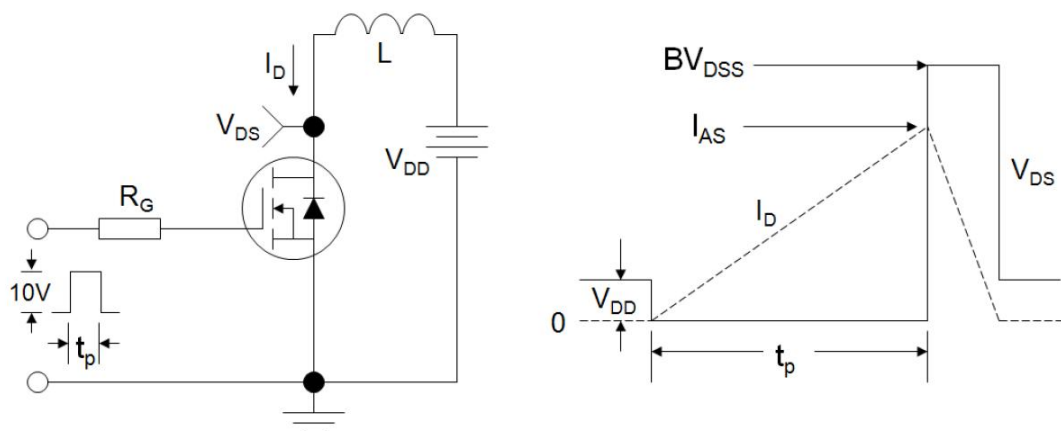
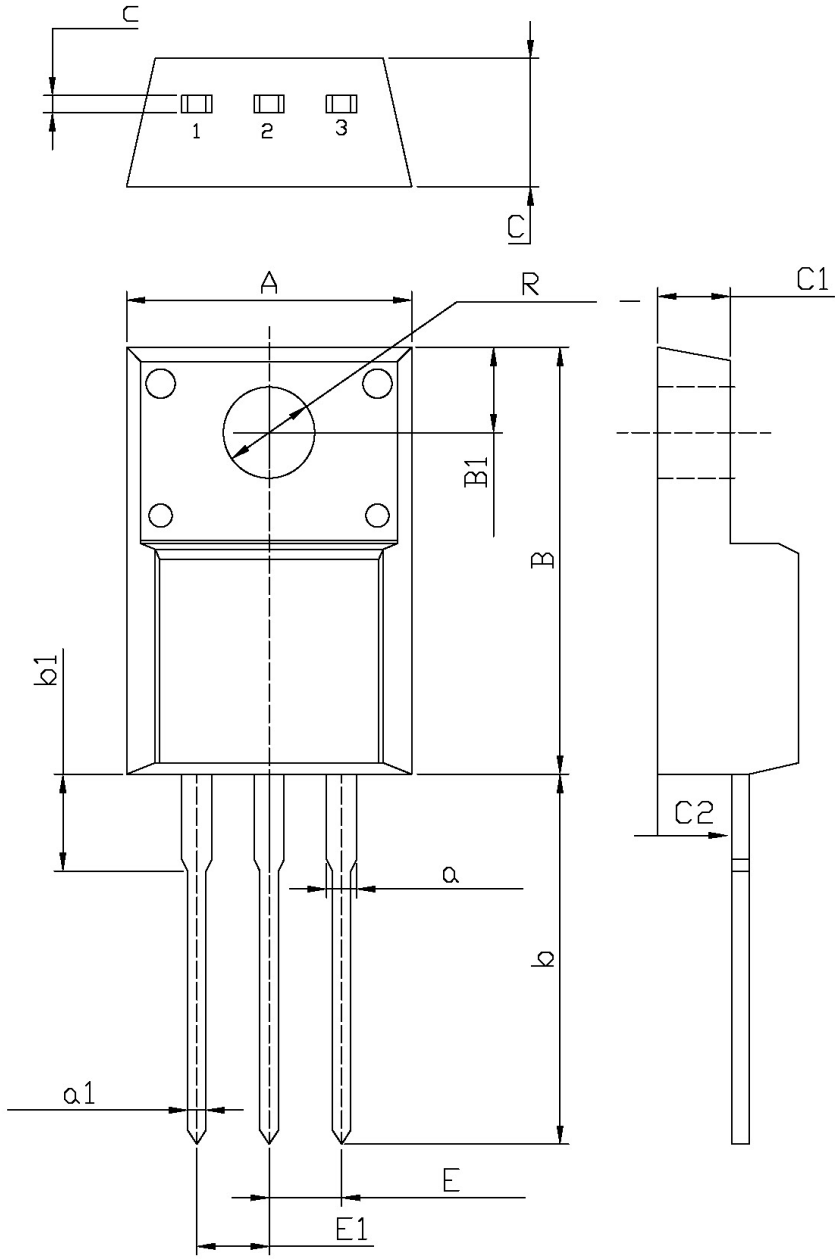


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



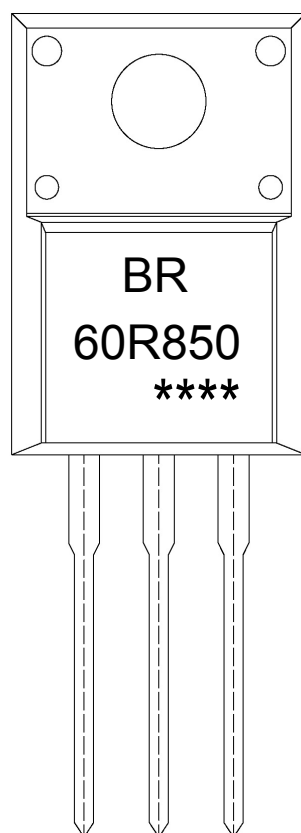
外形尺寸图 / Package Dimensions

TO-220FL 单位: mm



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
C	4.5	4.9	b1	2.90	3.90
C	0.4	0.6	a	1.08	1.48
A	9.96	10.36	a1	0.70	0.90
B	15.67	16.07	E	2.34	2.74
B1	3.30	3.50	E1	2.34	2.74
R	3.08	3.28	C1	2.34	2.74
b	12.48	13.48	C2	2.56	2.96

印章说明 / Marking Instructions



说明：

BR： 为公司代码

60R850： 为型号代码

****： 为生产批号代码，随生产批号变化。

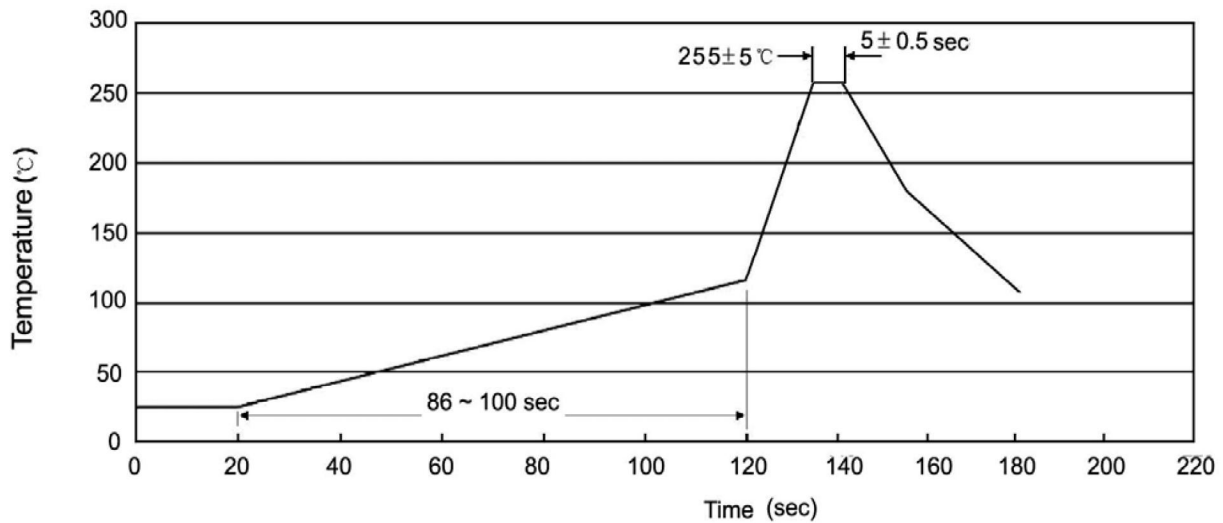
Note:

BR: Company Code.

60R850: Product Type.

****: Lot No. Code, code change with Lot No.

波峰焊温度曲线图(无铅) / Temperature Profile for Dip Soldering(Pb-Free)



说明：

- 1、预热温度 25 ~ 150°C，时间 60 ~ 90sec;
- 2、峰值温度 255±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:255±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：270±5°C

时间：10±1 sec.

Temp.:270±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

套管包装 / TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-220FL	50	20	1,000	5	5,000	532×33×7.0	555×164×50	575×290×180

使用说明 / Notices